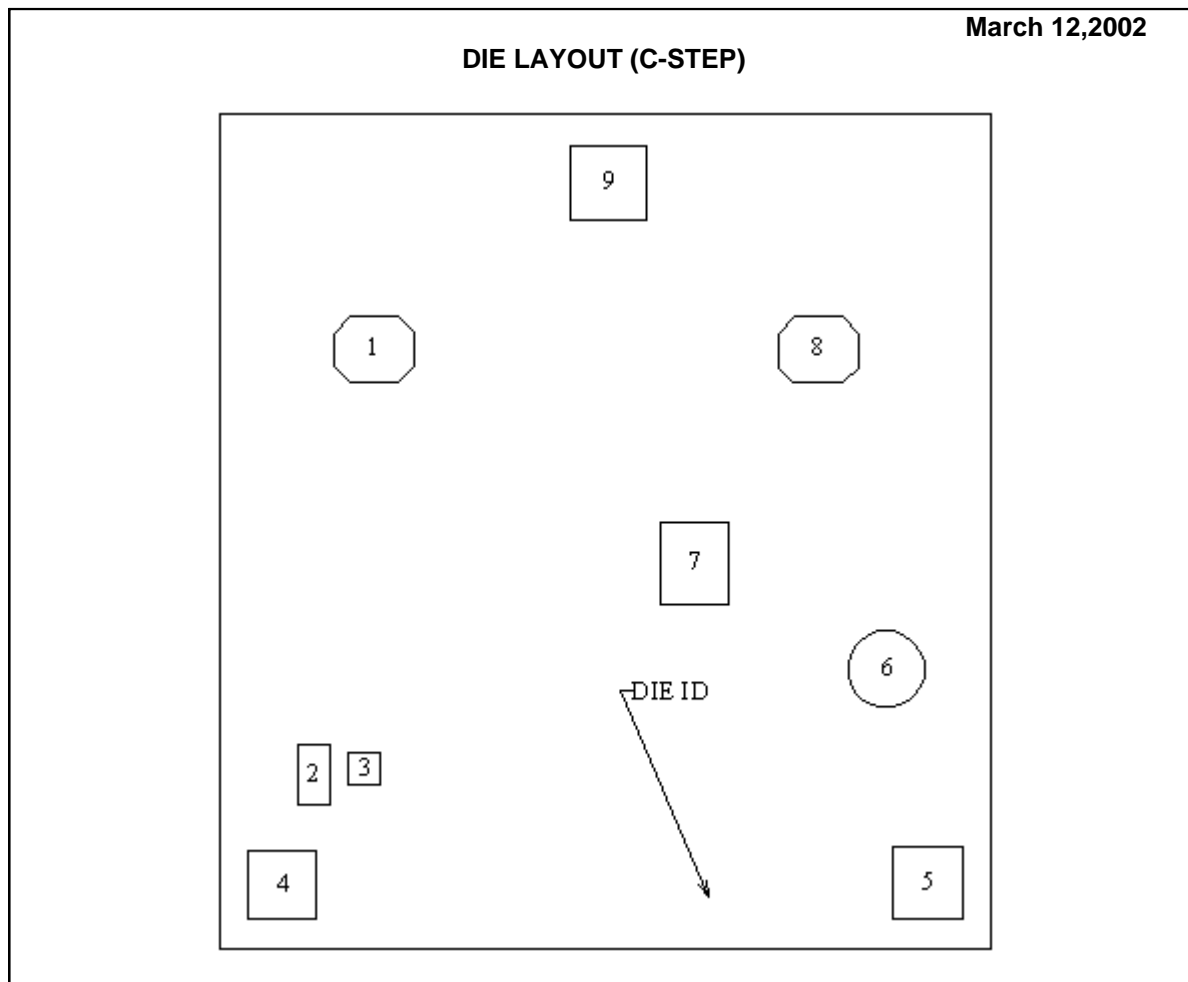


LM117HVH MD8 MW8
3-TERMINAL ADJUSTABLE REGULATOR



DIE/WAFER CHARACTERISTICS

Fabrication Attributes		General Die Information	
Physical Die Identification	117C	Bond Pad Opening Size (min)	229µm x 188µm
Die Step	C	Bond Pad Metalization	ALUMINUM
Physical Attributes		Passivation	VOM NITRIDE
Wafer Diameter	100mm	Back Side Metal	Gold
Die Size (Drawn)	2362µm x 2184µm 93mils x 86mils	Back Side Connection	OUTPUT
Thickness	254µm Nominal		
Min Pitch	146µm Nominal		

Special Assembly Requirements:

Note: Actual die size is rounded to the nearest micron.

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Die Bond Pad Coordinate Locations (C -Step)						
(Referenced to die center, coordinates in μm) NC = No Connection						
SIGNAL	PAD#	X/Y CORRINATES		PAD SIZE		
NAME	NUMBER	X	Y	X	Y	
OUTPUT	1	-655	516	229	x	188
NC	2	-827	-690	89	x	170
NC	3	-681	-673	91	x	91
OUTPUT	4	-914	-1001	193	x	198
ADJ	5	913	-997	196	x	206
NC	6	800	-391	208	x	208
INPUT	7	254	-91	193	x	234
OUTPUT	8	603	514	226	x	185
INPUT	9	10	987	213	x	211

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3-TERMINAL ADJUSTABLE REGULATOR

Life Support Policy

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety of effectiveness.



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